

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| | |
| Name | Execution Date |
| HOJUNG KIM | 09/05/2016 |
| KICHUL KIM | 09/12/2016 |
| HONGSEOK LEE | 09/13/2016 |
| RECEIVING PARTY DATA | |
| Name: | SAMSUNG ELECTRONICS CO., LTD. |
| Street Address: | 129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO |
| City: | SUWON-SI |
| State/Country: | KOREA, REPUBLIC OF |
| Postal Code: | 16677 |
| Name: | UNIVERSITY OF SEOUL INDUSTRY COOPERATION FOUNDATION |
| Street Address: | 163, SEOULSIRIPDAE-RO, DONGDAEMUN-GU |
| City: | SEOUL |
| State/Country: | KOREA, REPUBLIC OF |
| Postal Code: | 02504 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 15270647 |
| CORRESPONDENCE DATA | |
| Fax Number: | (202)293-7860 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 202-293-7060 |
| Email: | zamadou@sughrue.com, sughrue@sughrue.com |
| Correspondent Name: | SUGHRUE MION, PLLC |
| Address Line 1: | 2100 PENNSYLVANIA AVENUE, N.W. |
| Address Line 2: | SUITE 800 |
| Address Line 4: | WASHINGTON, D.C. 20037 |
| ATTORNEY DOCKET NUMBER: | Q228486 |
| NAME OF SUBMITTER: | ZIRIATOU AMADOU, TEAMS DEPARTMENT |

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| SIGNATURE: | /ziriadouamadou/ |
| DATE SIGNED: | 09/20/2016 |
| | This document serves as an Oath/Declaration (37 CFR 1.63). |
| Total Attachments: 3 source=Q228486DeclarationandAssignmentExecuted#page1.tif source=Q228486DeclarationandAssignmentExecuted#page2.tif source=Q228486DeclarationandAssignmentExecuted#page3.tif | |

Korean Language Assignment with Declaration

위에 표시된 출원은 본인이 신장하였거나 또는 신청하도록 허가를 받았습니니다.

The above identified application was made or was authorized to be made by me.

본인은, 본인이 본 출원에서 청구된 발명의 원 발명자 또는 원 공동 발명자라고 믿습니니다.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

본인은 본 양도 및 선언서 제출과 관련된 출원의 내용을 검토하였으며 아울러 이해합니다.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

본인은 연방 규정 코드 제 37 장 제 1.56 항에 규정된 바에 따라, 특허성의 판단에 중요한 본인이 아는 모든 정보를 특허청에 공개할 의무가 있음을 알고 있습니다.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

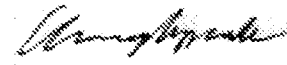
본 양도 및 선언서 내에 의도적 허위 진술이 있을 경우 미합중국 코드 제 18장의 1001 항에 의거 벌금이나 5년 이하의 징역 또는 두 가지 처벌을 모두 받을 수 있음을 인정합니다.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

STATEMENT OF ACCURATE TRANSLATION IN ACCORDANCE WITH 37 CFR 1.69(b):

The assignment with declaration is an accurate translation of the corresponding English language assignment with declaration.

Signature



Date

March 17, 2014

NAME OF SOLE OR FIRST INVENTOR:

단독 혹은 최초 발명자의 성명

| | | | |
|--|--------|--------------------------------|-----|
| Given Name (first and middle [if any]) 이름(성씨는 제외) | Hojung | Family Name or Surname 성(姓) | KIM |
|--|--------|--------------------------------|-----|

| | | | |
|---------------------------------|-------------------|------------|-------------------|
| Inventor's signature 발명자의 서명 | <i>Hojung Kim</i> | Date 일자 | September 5, 2016 |
|---------------------------------|-------------------|------------|-------------------|

Residence:
거주지: Suwon-si, Gyeonggi-do, Republic of Korea

Mailing Address:
우편 주소: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea

NAME OF SECOND INVENTOR:

두번째 발명자의 성명

| | | | |
|--|--------|--------------------------------|-----|
| Given Name (first and middle [if any]) 이름(성씨는 제외) | Kichul | Family Name or Surname 성(姓) | KIM |
|--|--------|--------------------------------|-----|

| | | | |
|---------------------------------|--------------------|------------|--------------------|
| Inventor's signature 발명자의 서명 | <i>Kim, Kichul</i> | Date 일자 | September 12, 2016 |
|---------------------------------|--------------------|------------|--------------------|

Residence:
거주지: Seoul, Republic of Korea

Mailing Address:
우편 주소: c/o University of Seoul Industry Cooperation Foundation, 163, Seoulsiripdae-ro, Dongdaemun-gu, Seoul, 02504, Republic of Korea

NAME OF THIRD INVENTOR:

세번째 발명자의 성명

| | | | |
|--|----------|--------------------------------|-----|
| Given Name (first and middle [if any]) 이름(성씨는 제외) | Hongseok | Family Name or Surname 성(姓) | LEE |
|--|----------|--------------------------------|-----|

| | | | |
|---------------------------------|----------------------|------------|------------|
| Inventor's signature 발명자의 서명 | <i>Lee Hong-Seok</i> | Date 일자 | 2016.09.13 |
|---------------------------------|----------------------|------------|------------|

Residence:
거주지: Seongnam-si, Gyeonggi-do, Republic of Korea

Mailing Address:
우편 주소: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea